

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	2SK066500L
Manufacturer:	Panasonic Electronic Components
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/panasonic-electronic-components/2sk066500l.html>

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Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

2SK0665 (2SK665)

Silicon N-channel MOSFET

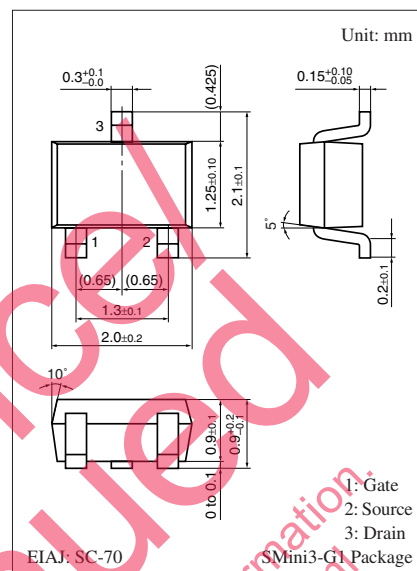
For switching circuits

■ Features

- High-speed switching
- Small drive current owing to high input impedance
- High electrostatic breakdown voltage

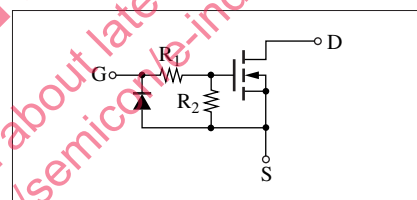
■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-source voltage	V_{DS}	20	V
Gate-source voltage (Drain open)	V_{GSO}	8	V
Drain current	I_D	100	mA
Peak drain current	I_{DP}	200	mA
Power dissipation	P_D	150	mW
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$



Marking Symbol: 3Q

Internal Connection



■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-source surrender voltage	V_{DSS}	$I_D = 100 \mu\text{A}$, $V_{GS} = 0$	20			V
Drain-source cutoff current	I_{DSS}	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$			10	μA
Gate-source cutoff current	I_{GSS}	$V_{GS} = 8 \text{ V}$, $V_{DS} = 0$	40		80	μA
Gate threshold voltage	V_{th}	$I_D = 100 \mu\text{A}$, $V_{DS} = V_{GS}$	1.5		3.5	V
Forward transfer admittance	$ Y_{fs} $	$I_D = 20 \text{ mA}$, $V_{DS} = 5 \text{ V}$, $f = 1 \text{ kHz}$	20			mS
Drain-source ON resistance	$R_{DS(on)}$	$I_D = 20 \text{ mA}$, $V_{GS} = 5 \text{ V}$			50	Ω
Output voltage high-level	V_{OH}	$V_{DD} = 5 \text{ V}$, $V_{GS} = 1 \text{ V}$, $R_L = 200 \Omega$	4.5			V
Output voltage low-level	V_{OL}	$V_{DD} = 5 \text{ V}$, $V_{GS} = 5 \text{ V}$, $R_L = 200 \Omega$			1.0	V
Input resistance *1	$R_1 + R_2$		100		200	k Ω
Turn-on time *2, 3	t_{on}	$V_{DD} = 5 \text{ V}$, $V_{GS} = 0 \text{ V}$ to 5 V , $R_L = 200 \Omega$			1.0	μs
Turn-off time *2, 3	t_{off}	$V_{DD} = 5 \text{ V}$, $V_{GS} = 5 \text{ V}$ to 0 V , $R_L = 200 \Omega$			1.0	μs

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

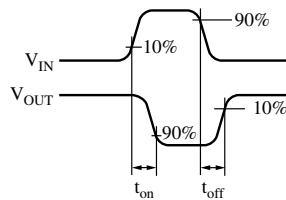
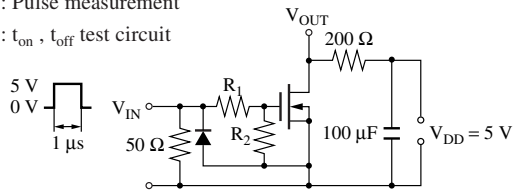
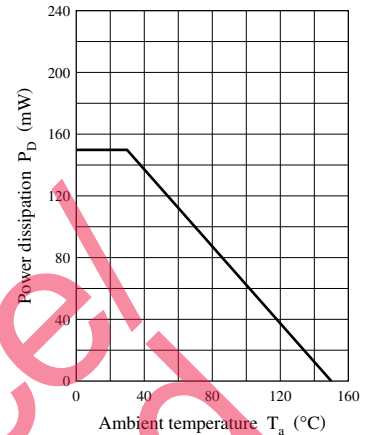
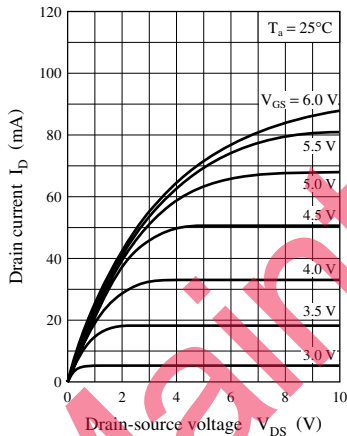
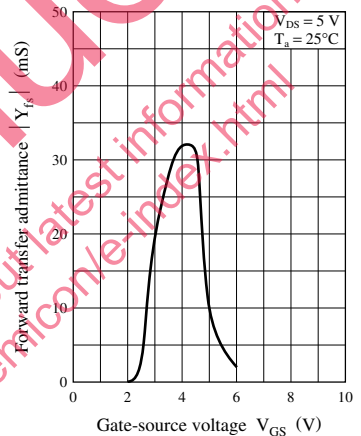
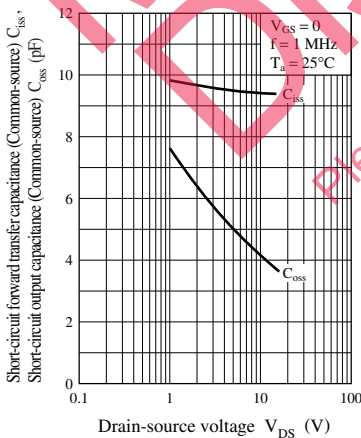
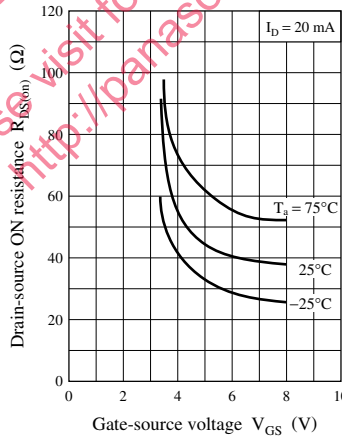
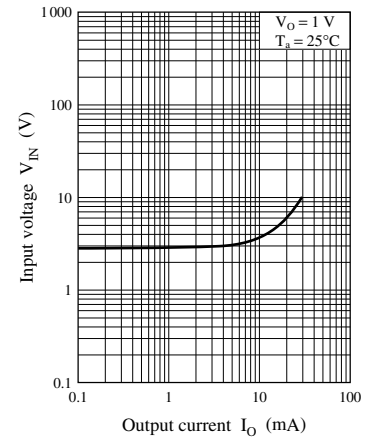
Note) The part number in the parenthesis shows conventional part number.

■ Electrical Characteristics (continued)

Note) (continued)

2. *1: Resistance ratio $R_1/R_2 = 1/50$ (typ.)

*2: Pulse measurement

*3: t_{on} , t_{off} test circuit $P_D - T_a$  $I_D - V_{DS}$  $I_D - V_{GS}$  $|Y_{fs}| - V_{GS}$  $C_{iss}, C_{oss} - V_{DS}$  $R_{DS(on)} - V_{GS}$  $V_{IN} - I_O$ 

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